Advance Information

MPC755BLDPNS/D Rev. 2, 4/2002

MPC755 Part Number Specification for the XPC755BxxnnnLD and XPC745BxxnnnLD Series





Motorola Part Numbers Affected:

XPC755BRX300LD XPC755BRX350LD XPC755BRX400LD XPC755BPX300LD XPC755BPX350LD XPC755BPX400LD XPC745BPX300LD XPC745BPX350LD This document describes part-number-specific changes to recommended operating conditions and revised electrical specifications, as applicable, from those described in the general *MPC755 RISC Microprocessor Hardware Specifications* (order # MPC755EC/D).

Specifications provided in this document supersede those in the *MPC755 RISC Microprocessor Hardware Specifications*, Rev. 4 or later, for the part numbers listed in Table A only. Specifications not addressed herein are unchanged. Because this document is frequently updated, refer to http://www.motorola.com/semiconductors or to your Motorola sales office for the latest version.

Note that headings and table numbers in this document are not consecutively numbered. They are intended to correspond to the heading or table affected in the general hardware specification.

Part numbers addressed in this document are listed in Table A. For more detailed ordering information see Section 1.11.

Table A. Significant Differences from Hardware Specification by Part Number

Motorola	Oper	at <mark>ing Con</mark> dition	s	Significant Differences from
Part Number	CPU Frequency	V _{DD}	T _J (°C)	Hardware Specification
XPC755BRX300LD	300 MHz	2.0 V ±100 mV	0 to 105	2.0 V/1.8 V I/O voltage supported, 2.5 V
XPC755BRX350LD	350 MHz			I/O not supported; all nominal core voltages are 2.0 V ±100 mV; AC timing
XPC755BRX400LD	400 MHz	- 5	The state of the s	different for processor bus and L2 bus interfaces; L2 bus interface AC timing
XPC755BPX300LD	300 MHz	R. 11	41:	not guaranteed in 1.8 V/2.0 V mode.
XPC755BPX350LD	350 MHz			
XPC755BPX400LD	400 MHz			



General Parameters

Table A. Significant Differences from Hardware Specification by Part Number (continued)

Motorola	Operating Conditions			Significant Differences from
Part Number	CPU Frequency	V _{DD}	T _J (°C)	Hardware Specification
XPC745BPX300LD	300 MHz	2.0 V ±100 mV		2.0 V/1.8 V I/O voltage supported,
XPC745BPX350LD	350 MHz			2.5 V I/O not supported; all nominal core voltages are 2.0 V ±100 mV; AC timing different for processor bus interface.

Note: The X prefix in a Motorola PowerPC part number designates a "Pilot Production Prototype" as defined by Motorola SOP 3-13. These are from a limited production volume of prototypes manufactured, tested, and Q.A. inspected on a qualified technology to simulate normal production. These parts have only preliminary reliability and characterization data. Before pilot production prototypes may be shipped, written authorization from the customer must be on file in the applicable sales office acknowledging the qualification status and the fact that product changes may still occur while shipping pilot production prototypes.

There are currently no known errata for the part numbers addressed by this data sheet.

1.3 General Parameters

The following general parameters apply to all part numbers described herein:

Core power supply $2.0 \text{ V} \pm 100 \text{ mV DC}$ (nominal; see Table 3 for recommended operating

conditions)

I/O power supply $1.8 \text{ V} \pm 100 \text{ mV}$ dc (processor bus interface only; not supported on

L2 interface), or

 $2.0 \text{ V} \pm 100 \text{ mV}$ dc (processor bus interface only; not supported on

L2 interface), or

3.3 V ± 165 mV dc (input thresholds are configuration pin selectable)

Note that part revisions prior to Rev. 2.8 (Rev. E) do not support core voltages down to 1.8 V.

1.4.1 DC Electrical Characteristics

All part numbers affected by this specification support 3.3 V and 1.8 V/2.0 V I/O voltages, but do not support 2.5 V I/O voltages. Table 2 describes the input threshold voltage settings. These settings apply to all device revisions prior to Rev. 2.8 (Rev. E), including all part numbers described herein. Note that the MPC745 does not provide an L2 interface.

Table 2. Input Threshold Voltage Setting

BVSEL Signal	L2VSEL Signal	Processor Bus Interface Voltage	L2 Bus Interface Voltage
0	0	1.8 V or 2.0 V	1.8 V or 2.0 V
0	1	1.8 V or 2.0 V	3.3 V
1	0	3.3 V	1.8 V or 2.0 V
1	1	3.3 V	3.3 V

Caution: The input threshold selection must agree with the OV_{DD}/L2OV_{DD} voltages supplied.

Table 3 provides the recommended operating conditions for all device revisions prior to Rev. 2.8 (Rev. E), including all part numbers described herein.

Table 3. Recommended Operating Conditions

Characterist	Symbol	Recommended Value	Unit	
Core supply voltage		V _{DD}	2.0 ±100 mV	V
PLL supply voltage	AV _{DD}	2.0 ±100 mV	V	
L2 DLL supply voltage	L2AV _{DD}	2.0 ±100 mV	V	
Processor bus supply voltage	BVSEL = 0	OV _{DD}	1.8 ±100 mV or 2.0 ±100 mV	V
	BVSEL = 1	OV _{DD}	3.3 ±165 mV	V
L2 bus supply voltage	L2VSEL = 0	L2OV _{DD}	1.8 ±100 mV or 2.0 ±100 mV	V
	L2VSEL = 1	L2OV _{DD}	3.3 ±165 mV	V

Note: These are the recommended and tested operating conditions. Proper device operation outside of these conditions is not guaranteed.

Table 6 provides the DC electrical specifications for all device revisions prior to Rev. 2.8 (Rev. E), including all part numbers described herein.

Table 6. DC Electrical Specifications

At recommended operating conditions (see Table 3)

Characteristic	Nominal Bus Voltage ¹	Symbol	Min	Max	Unit	Notes
Input high voltage (all inputs except	1.8/2.0	V _{IH}	$0.65 \times (L2)OV_{DD}$	(L2)OV _{DD} + 0.3	V	2,3
SYSCLK)	3.3	V _{IH}	2.0	(L2)OV _{DD} + 0.3	V	2,3
Input low voltage (all inputs except	1.8/2.0	V _{IL}	-0.3	$0.35 \times (L2)OV_{DD}$	V	2
SYSCLK)	3.3	V _{IL}	-0.3	0.8	V	
SYSCLK input high voltage	1.8/2.0	KV _{IH}	1.5	OV _{DD} + 0.3	V	
	3.3	KV _{IH}	2.4	OV _{DD} + 0.3	V	
SYSCLK input low voltage	1.8/2.0	KV _{IL}	-0.3	0.2	V	
	3.3	KV _{IL}	-0.3	0.4	V	

General Parameters

Table 6. DC Electrical Specifications (continued)

At recommended operating conditions (see Table 3)

Characteristic	Nominal Bus Voltage ¹	Symbol	Min	Max	Unit	Notes
Output high voltage, I _{OH} = -6 mA	1.8/2.0	V _{OH}	(L2)OV _{DD} - 0.45	_	V	
	3.3	V _{OH}	2.4	_	V	
Output low voltage, I _{OL} = 6 mA	1.8/2.0	V _{OL}	_	0.45	V	
	3.3	V _{OL}	_	0.4	V	

Notes:

- 1. Nominal voltages; see Table 3 for recommended operating conditions.
- 2. For processor bus signals, the reference is OV_{DD}. L2OV_{DD} is the reference for the L2 bus signals.
- 3. Excludes test signals (LSSD_MODE, L1_TSTCLK, L2_TSTCLK) and IEEE 1149.1 boundary scan (JTAG) signals.

1.4.2.2 Processor Bus AC Specifications

All part numbers described herein have slower AC timing characteristics than later revisions of the part. The affected processor bus AC timing specifications are given in Table 10.

Table 10. Processor Bus AC Timing Specifications

At recommended operating conditions (see Table 3)

Parameter	Symbol	300, 350,	400 MHz	Unit	
i arameter	Cymbol	Min	Max	Oilit	
Input Hold Times: All Inputs	t _{IXKH}	0.6	_	ns	
Valid Times: All Outputs	t _{KHOV}	_	4.5	ns	

1.4.2.4 L2 Bus AC Specifications

The AC timing characteristics of the L2 bus interface in 3.3 V mode are slower for parts affected by this specification than for later revisions of the part. Additionally, the AC timing of the L2 interface is not guaranteed in 1.8 V/2.0 V mode. These affect the following part numbers only:

- XPC755BRX300LD
- XPC755BRX350LD
- XPC755BRX400LD
- XPC755BPX300LD
- XPC755BPX350LD
- XPC755BPX400LD

Table 12 provides the L2 bus interface AC timing specifications for the MPC755 described in this document when the L2 bus interface is in 3.3 V mode only. The L2 bus interface of the part described herein is not tested in 1.8 V/2.0 V mode and does not meet these specifications. The L2 interface output drivers may display a non-linear, stepped behavior when switching that prolongs the rise and fall times in this mode. This behavior is dependent on L2OV_{DD}, the impedance of the circuit board, and operating conditions of the processor. In a worst-case device, at L2OV_{DD} = 1.8 V and $T_j = 105$ °C, the driver output impedance is 55 Ω ; at L2OV_{DD} = 2.0 V and $T_j = 105$ °C, the driver output impedance is 47 Ω . The non-linear behavior results

when the driver output impedance is greater than the board impedance and can cause reflected wave switching instead of incident wave switching. The voltage level at which the step will occur is $V_{step} = L20V_{DD} \times [Z_{board}/(Z_{out} + Z_{board})]$. If V_{step} is less than the input high threshold voltage of the SRAM, the SRAM will not recognize a logical high on a given signal until the reflected wave arrives. The time delay between the arrival of the incident wave and the reflected wave is determined solely by the propagation delay of the signal. Because of these issues, Motorola does not recommend or support the use of the L2 bus interface of the affected part numbers described herein in 1.8 V/2.0 V mode.

Table 12. L2 Bus Interface AC Timing Specifications

At recommended operating conditions (see Table 3)

Parameter	Symbol	300 MHz		350 MHz		400 MHz		Unit	Notes
raiametei	Symbol	Min	Max	Min	Max	Min	Max	Oilit	Notes
Setup Times: Data and parity	t _{DVL2CH}	1.5	_	1.5	_	1.5	_	ns	2
Input Hold Times: Data and parity	t _{DXL2CH}	0.5	_	0.5	_	0.5	_	ns	2
Valid Times: All outputs when L2CR[14–15] = 00 All outputs when L2CR[14–15] = 01 All outputs when L2CR[14–15] = 10 All outputs when L2CR[14–15] = 11			3.6 3.8 4.0 4.2	_ _ _ _	3.6 3.8 4.0 4.2		3.6 3.8 4.0 4.2	ns	3, 4
L2SYNC_IN to high impedance: All outputs when L2CR[14–15] = 00 All outputs when L2CR[14–15] = 01 All outputs when L2CR[14–15] = 10 All outputs when L2CR[14–15] = 11			3.5 4.0 4.2 4.5	_ _ _	3.5 4.0 4.2 4.5	_ _ _ _	3.5 4.0 4.2 4.5	ns	3, 5

Notes:

- 2. All input specifications are measured from the midpoint of the signal in question to the midpoint voltage of the rising edge of the input L2SYNC_IN. Input timings are measured at the pins.
- 3. All output specifications are measured from the midpoint voltage of the rising edge of L2SYNC_IN to the midpoint of the signal in question. The output timings are measured at the pins. All output timings assume a purely resistive $50-\Omega$ load.
- 4. The outputs are valid for both single-ended and differential L2CLK modes. For pipelined registered synchronous BurstRAMs, L2CR[14–15] = 01 or 10 is recommended. For pipelined late write synchronous BurstRAMs, L2CR[14–15] = 11 is recommended.
- 5. Guaranteed by design and characterization.

1.10 Ordering Information

1.10.1 Part Numbers Addressed by This Specification

Table 20 provides the ordering information for the MPC755 parts described in this specification.

Table 20. Part Numbering Nomenclature

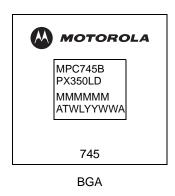
XPC	XXX	В	XX	nnn	X	X
Product Code	Part Identifier	Process Descriptor	Package	Processor Frequency ¹	Application Modifier	Revision Level
XPC ²	755 745	B = HiP4DP	PX = PBGA RX = CBGA	300 350 400	L: 2.0 V ±100 mV 0° to 105°C	D: 2.7; PVR = 0008 3203

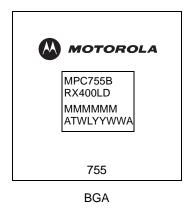
Notes:

- Processor core frequencies supported by parts addressed by this specification only. Parts addressed by other specifications may support other maximum core frequencies.
- 2. The X prefix in a Motorola part number designates a "Pilot Production Prototype" as defined by Motorola SOP 3-13. These are from a limited production volume of prototypes manufactured, tested, and Q.A. inspected on a qualified technology to simulate normal production. These parts have only preliminary reliability and characterization data. Before pilot production prototypes may be shipped, written authorization from the customer must be on file in the applicable sales office acknowledging the qualification status and the fact that product changes may still occur while shipping pilot production prototypes.

1.10.3 Part Marking

Parts are marked as the example shown in Figure 29.





Notes:

MMMMMM is the 6-digit mask number. ATWLYYWWA is the traceability code.

CCCCC is the country of assembly. This space is left blank if parts are assembled in the United States.

Figure 29. Part Marking for BGA Device

Document Revision History

Table B provides a revision history for this hardware specification.

Table B. Document Revision History

Revision No.	Substantive Change(s)		
0–1	Initial releases.		
2	Updated document.		
	Corrected Section 1.4.2.4.		

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